

CS13N65P,CS13N65F

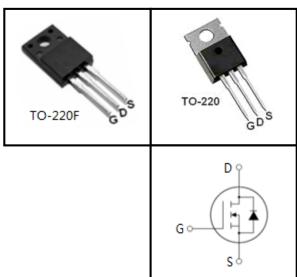
650V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



| Device Marking and Package Information | | | |
|--|---------|----------|--|
| Device | Package | Marking | |
| CS13N65F | TO-220F | CS13N65F | |
| CS13N65P | TO-220P | CS13N65P | |

| Absolute Maximum Ratings T _C = 25°C, unless otherwise noted | | | | | |
|--|-----------------------------------|----------|--------|------|--|
| Baramatar | Symbol | Va | | | |
| Parameter | | TO-220F | TO-220 | Unit | |
| Drain-Source Voltage (V _{GS} = 0V) | V _{DSS} | 650 | | V | |
| Continuous Drain Current | I _D | 13 | | A | |
| Pulsed Drain Current (note1) | I _{DM} | 52 | | A | |
| Gate-Source Voltage | V _{GSS} | ± | 30 | V | |
| Single Pulse Avalanche Energy (note2) | E _{AS} | 387 | | mJ | |
| Avalanche Current (note1) | I _{AS} | 8.8 | | A | |
| Repetitive Avalanche Energy (note1) | E _{AR} | 232 | | mJ | |
| Power Dissipation (T _C = 25°C) | P _D | 70 | 65 | w | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55~+150 | | °C | |

| Thermal Resistance | | | | |
|---|-------------------|---------|--------|------|
| Deservation | O. makes I | Va | | |
| Parameter | Symbol | TO-220F | TO-220 | Unit |
| Thermal Resistance, Junction-to-Case | R _{thJC} | 1. 78 | 0.89 | |
| Thermal Resistance, Junction-to-Ambient | R _{thJA} | 62.5 | 60 | K/W |

Suzhou Convert SemiConductor Co.,Ltd.



CS13N65P,CS13N65F

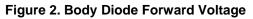
| Specifications $T_J = 25^{\circ}C$, unless otherwise noted | | | | | | | |
|--|---------------------|---|-------|------|------|---------|--|
| Parameter | Symbol | Test Conditions | Value | | | l l mit | |
| | | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | _ | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_{D} = 250 \mu A$ | 650 | | | V | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{o}C$ | | | 1 | μA | |
| Gate-Source Leakage | I _{GSS} | V_{GS} = $\pm 30V$ | | | ±100 | nA | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 3.0 | | 4.0 | V | |
| Drain-Source On-Resistance (Note3) | R _{DS(on)} | V _{GS} = 10V, I _D = 6.5A | | 0.52 | 0.65 | Ω | |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz | | 1779 | | pF | |
| Output Capacitance | C _{oss} | | | 183 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 25 | | | |
| Total Gate Charge | Q_{g} | $V_{DD} = 520V, I_D = 13A,$ $V_{GS} = 10V$ | | 62 | | nC | |
| Gate-Source Charge | Q _{gs} | | | 9 | | | |
| Gate-Drain Charge | Q_{gd} | | | 32 | | | |
| Turn-on Delay Time | t _{d(on)} | V_{DD} = 325V, I _D =13A, R _G = 25 Ω | | 49 | | ns | |
| Turn-on Rise Time | t _r | | | 38 | | | |
| Turn-off Delay Time | t _{d(off)} | | | 245 | | | |
| Turn-off Fall Time | t _f | | | 114 | | | |
| Drain-Source Body Diode Character | istics | | | | | | |
| Continuous Body Diode Current | ۱ _s | T 25.00 | | | 13 | A | |
| Pulsed Diode Forward Current | I _{SM} | T _C = 25 °C | | | 52 | | |
| Body Diode Voltage | V _{SD} | T _J = 25°C, I _{SD} = 6.5A, V _{GS} = 0V | | | 1.4 | V | |
| Reverse Recovery Time | t _{rr} | V _{GS} = 0V,I _S = 13A, di _F /dt =100A /µs | | 582 | | ns | |
| Reverse Recovery Charge | Q _{rr} | | | 3.5 | | μC | |

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 10.0mH, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 °C
- 3. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)



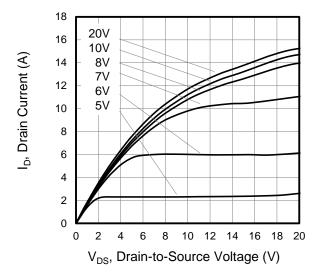


Figure 3. Drain Current vs. Temperature

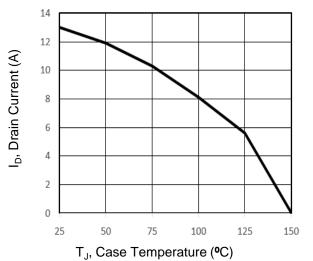
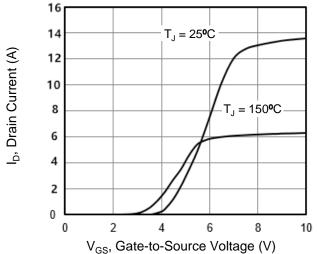


Figure 5. Transfer Characteristics



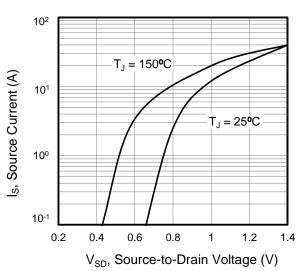


Figure 4. BV_{DSS} Variation vs. Temperature

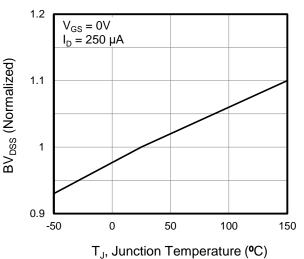
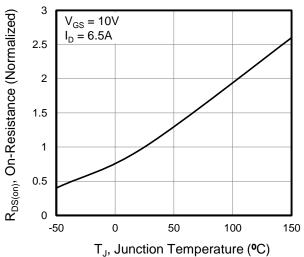
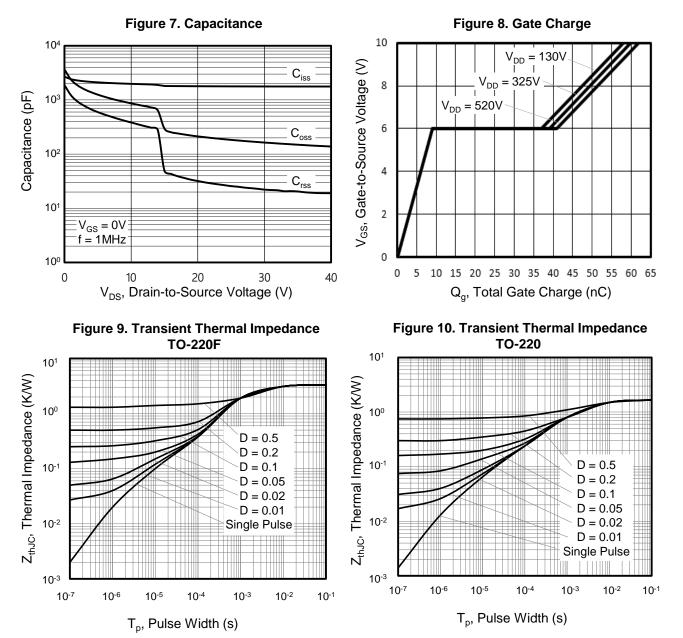


Figure 6. On-Resistance vs. Temperature





Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted





CS13N65P,CS13N65F



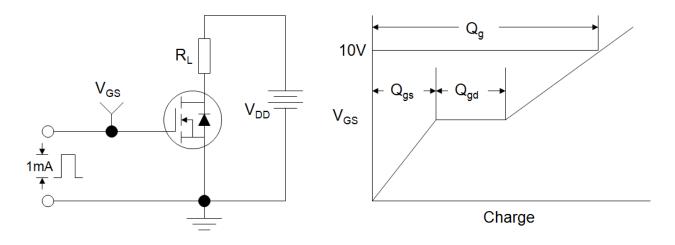


Figure B: Resistive Switching Test Circuit and Waveform

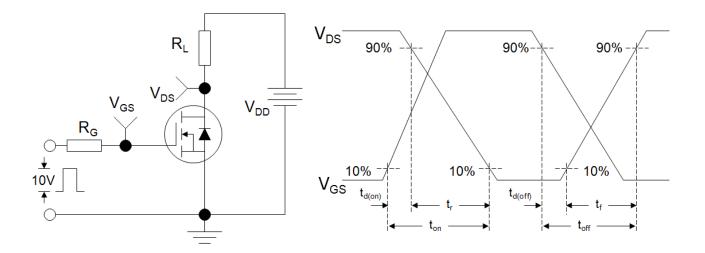
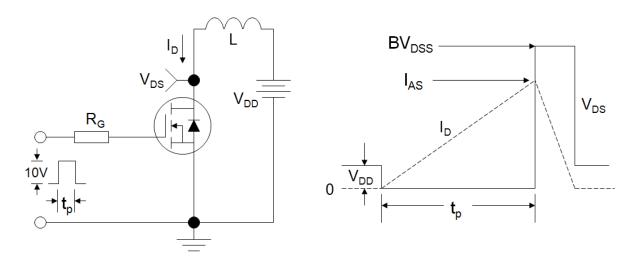


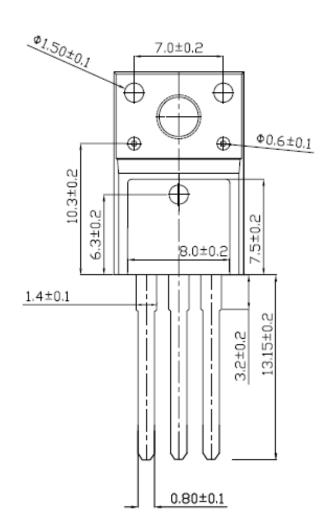
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

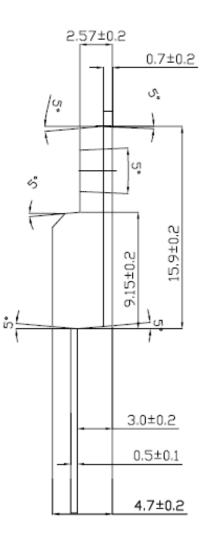






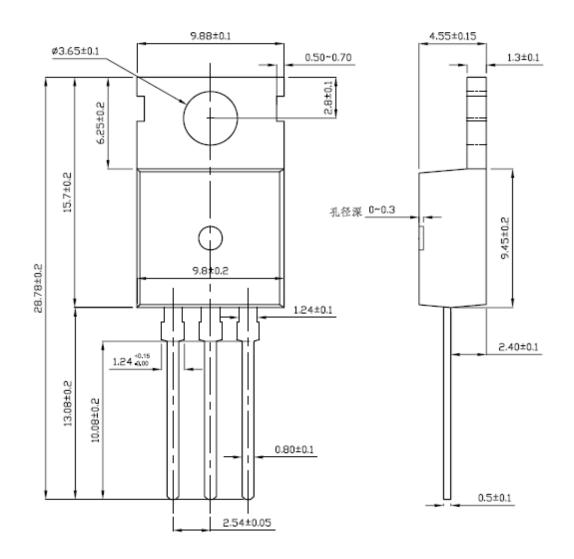
TO-220F







TO-220





Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Suzhou Convert does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Suzhou Convert.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless. Customers using or selling Suzhou Convert products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Suzhou Convert for any damages arising or resulting from such use or sale.

Suzhou Convert disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Suzhou Convert's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Suzhou Convert SemiConductor CO., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Suzhou Convert products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Suzhou Convert believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.